MP7628

XEXAR

5 V CMOS Quad Multiplying 8-Bit Digital-to-Analog Converter

FEATURES

- Readback Capability for all DACs
- On-Chip Latches for All DACs
- Linearity Grades to ±1/8 LSB
- Single Supply Voltage (5 Volt)
- DACs Matched to 1%
- Four Quadrant Multiplication
- Microprocessor TTL/CMOS Compatible
- Latch-Up Free
- Dual Version: MP7529B

APPLICATIONS

- Microprocessor Controlled Gain and Attenuation Circuits
- Microprocessor Controlled/Programmable Power Supplies
- Hardware Redundant Applications Requiring
 Data Readback

GENERAL DESCRIPTION

The MP7628 is a quad 8-bit Digital-to-Analog Converter designed using a decoded DAC architecture featuring excellent DAC-to-DAC matching and guaranteed monotonicity.

Separate on-chip latches are provided for each DAC to allow easy microprocessor interface.

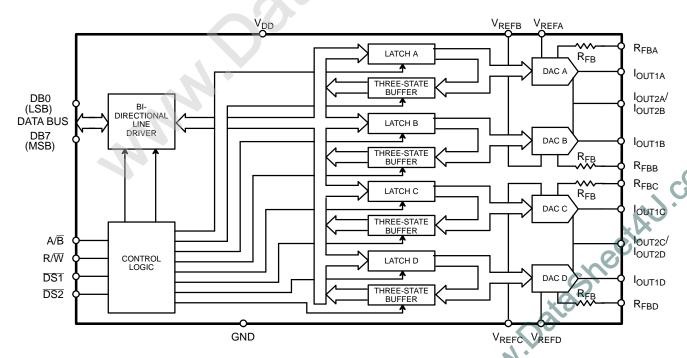
The readback function allows the user to poll or read the data latches, eliminating the need for storing information in RAM. In the event the microprocessor power supply is interrupted, it can poll the DACs to establish the last known system state.

Data is transferred into any of the four DAC data latches via common 8-bit TTL/CMOS compatible input port. Control inputs DS1, DS2 and A/B determine which DAC is to be loaded. The MP7628's load cycle is similar to the write cycle of a random access memory and the device is bus compatible with most 8-bit microprocessors.

The device operates at +5 V power supply and dissipates less than 5mW.

All DACs offer excellent four quadrant multiplication characteristics with a separate reference input and feedback resistor for each DAC.

SIMPLIFIED BLOCK DIAGRAM



TOM



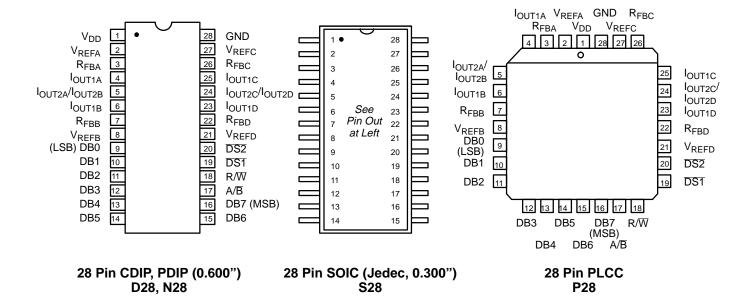
ORDERING INFORMATION

Package Type	Temperature Range	Part No.	INL (LSB)	DNL (LSB)	Gain Error (% FSR)
Plastic Dip	−40 to +85°C	MP7628JN	<u>+</u> 1/2	<u>+</u> 1/2	<u>+</u> 1.8
Plastic Dip	–40 to +85°C	MP7628KN	<u>+</u> 1/4	<u>+</u> 1/4	<u>+</u> 0.9
SOIC	–40 to +85°C	MP7628JS	<u>+</u> 1/2	<u>+</u> 1/2	<u>+</u> 1.8
SOIC	–40 to +85°C	MP7628KS	<u>+</u> 1/4	<u>+</u> 1/4	<u>+</u> 0.9
PLCC	–40 to +85°C	MP7628JP	<u>+</u> 1/2	<u>+</u> 1/2	<u>+</u> 1.8
PLCC	–40 to +85°C	MP7628KP	<u>+</u> 1/4	<u>+</u> 1/4	<u>+</u> 0.9
Ceramic Dip	–40 to +85°C	MP7628AD	<u>+</u> 1/2	<u>+</u> 1/2	<u>+</u> 1.8
Ceramic Dip	–40 to +85°C	MP7628BD	<u>+</u> 1/4	<u>+</u> 1/4	<u>+</u> 0.9
Ceramic Dip	−55 to +125°C	MP7628SD*	<u>+</u> 1/2	<u>+</u> 1/2	<u>+</u> 1.8
Ceramic Dip	−55 to +125°C	MP7628TD*	<u>+</u> 1/4	<u>+</u> 1/4	<u>+</u> 0.9

^{*}Contact factory for non-compliant military processing

PIN CONFIGURATIONS

See Packaging Section for Package Dimensions





PIN OUT DEFINITIONS

PIN NO.	NAME	DESCRIPTION
1	V _{DD}	Power Supply
2	V_{REFA}	Reference Voltage for DAC A
3	R _{FBA}	Feedback Resistor for DAC A
4	I _{OUT1A}	Current Output 1 DAC A
5	I _{OUT2A} / I _{OUT2B}	Current Output 2 DAC A/DAC B
6	I _{OUT1B}	Current Output 1 DAC B
7	R _{FBB}	Feedback Resistor for DAC B
8	V_{REFB}	Reference Voltage for DAC B
9	DB0	Data Input Bit 0 (LSB)
10	DB1	Data Input Bit 1
11	DB2	Data Input Bit 2
12	DB3	Data Input Bit 3
13	DB4	Data Input Bit 4
14	DB5	Data Input Bit 5
15	DB6	Data Input Bit 6
16	DB7	Data Input Bit 7 (MSB)
17	A/B	DAC Selection
18	R/W	Read/Write
19	DS1	Control 1
20	DS2	Control 2
21	V _{REFD}	Reference Voltage for DAC D
22	R _{FBD}	Feedback Resistor for DAC D
23	I _{OUT1D}	Current Output 1 DAC D
24	I _{OUT2C} / I _{OUT2D}	Current Output 2 DAC C/DAC D
25	I _{OUT1C}	Current Output 1 DAC C
26	R _{FBC}	Feedback Resistor for DAC C
27	V_{REFC}	Reference Voltage for DAC C
28	GND	Ground



ELECTRICAL CHARACTERISTICS

(V_{DD} = + 5 V, V_{REF} = +10 V unless otherwise noted)

Parameter	Symbol	Min	25°C Typ	Max	Tmin to Min	Tmax Max	Units	Test Conditions/Comments
STATIC PERFORMANCE ¹								FSR = Full Scale Range
Resolution (All Grades)	N	8			8		Bits	
Integral Non-Linearity (Relative Accuracy) J, A, S K, B, T	INL			<u>+</u> 1/2 <u>+</u> 1/4		<u>+</u> 1/2 <u>+</u> 1/4	LSB	End Point Linearity Spec.
Differential Non-Linearity J, A, S K, B, T	DNL			<u>+</u> 1/2 <u>+</u> 1/4		<u>+</u> 1/2 <u>+</u> 1/4	LSB	All grades monotonic over full temperature range.
Gain Error J, A, S K, B, T	GE			<u>+</u> 1.5 <u>+</u> 0.8		<u>+</u> 1.8 <u>+</u> 0.9	% FSR	Using Internal R _{FB} Digital Inputs = V _{INH}
Gain Temperature Coefficient ²	TC _{GE}					<u>+</u> 2	ppm/°C	Δ Gain/ Δ Temperature
Power Supply Rejection Ratio	PSRR			<u>+</u> 200		<u>+</u> 400	ppm/%	$ \Delta Gain/\Delta V_{DD} \Delta V_{DD} = \pm 5\%$ Digital Inputs = V_{INH}
Output Leakage Current (all)	I _{OUT1}			<u>+</u> 50		<u>+</u> 200	nA	Digital Inputs = V _{INL}
REFERENCE INPUT								
Voltage Range ² Input Resistance	R _{IN}	12		<u>+</u> 20 28	12	<u>+</u> 20 28	V kΩ	
DIGITAL INPUTS ³								
Logic Thresholds V _{INH} V _{INL} Input Leakage Current Input Capacitance ²	I _{LKG} C _{IN}	2.4	3	0.8 <u>+</u> 1	2.4	0.8 <u>+</u> 10	V V μA pF	
DATA BUS OUTPUTS								
Output Capacitance ² Input Leakage Current	C _{OUT} I _{LKG}		7	<u>+</u> 1		<u>+</u> 10	pF μA	
ANALOG OUTPUTS								
Propagation Delay ²		500			750		ns	From digital input to 90% of final analog output current
Output Capacitance ² Glitch Energy ²	C _{OUT} C _{OUT}	160	120 80		440		pF pF nVs	DAC Inputs all 1's DAC Inputs all 0's Typical for code transition from all 0's to all 1's



ELECTRICAL CHARACTERISTICS (CON'T)

Parameter	Symbol	Min	25°C Typ Max	Tmin to Min	Tmax Max	Units	Test Conditions/Comments
POWER SUPPLY ⁵							
Functional Voltage Range ² Supply Current	V _{DD} I _{DD}	4.5	5.5 50	4.5	5.5 50	V μA	All digital inputs = 0 V or all = 5 V
SWITCHING CHARACTERISTICS ^{2, 4}							
Data Write Time Write Strobe Req. Data Hold Time	t _W t _{DSW}	320 200 40		400 250 50		ns ns ns	
Data Read Time 3-state Hold Time Read Strobe Req.	t _R t _{TSHD} t _{DSR}	480 240 320		600 300 400		ns ns ns	

NOTES:

- ¹ Full Scale Range (FSR) is 10V for unipolar mode.
- ² Guaranteed but not production tested.
- Digital input levels should not go below ground or exceed the positive supply voltage, otherwise damage may occur.
- See timing diagrams.
- ⁵ Specified values guarantee functionality. Refer to other parameters for accuracy.

Specifications are subject to change without notice

ABSOLUTE MAXIMUM RATINGS (TA = +25°C unless otherwise noted)^{1, 2}

V _{DD} to GND+7 V	Storage Temperature65°C to +150°C
Digital Input Voltage to GND (2) . GND –0.5 to V_{DD} +0.5 V	Lead Temperature (Soldering, 10 seconds) +300°C
I_{OUT1} , I_{OUT2} to GND (2) GND -0.5 to V_{DD} +0.5 V	Package Power Dissipation Rating to 75°C
V _{REF} to GND <u>+</u> 25 V	CDIP, PDIP, SOIC, PLCC 1050mW
V _{RFB} to GND <u>+</u> 25 V	Derates above 75°C 14mW/°C

NOTES:

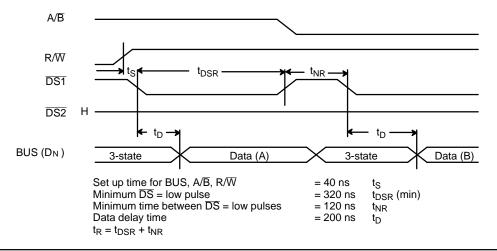
Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation at or above this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

Any input pin which can see a value outside the absolute maximum ratings should be protected by Schottky diode clamps (HP5082-2835) from input pin to the supplies.

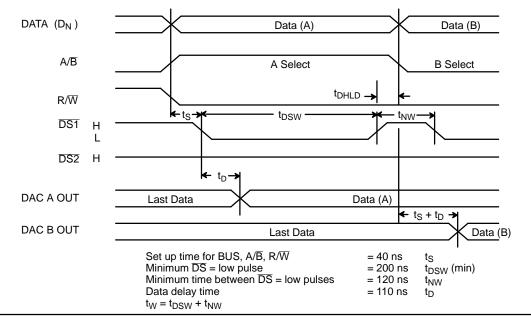




TIMING DIAGRAM READ CYCLE



TIMING DIAGRAM WRITE CYCLE



MODE SELECTION TABLE

DS1	DS2	A/B	R/W	MODE	DAC
L	Н	Н	L	WRITE	Α
L	Н	L	L	WRITE	В
l H	L	Н	L	WRITE	С
H	L	L	L	WRITE	D
L	Н	Н	Н	READ	Α
L	Н	L	Н	READ	В
H	L	Н	Н	READ	С
H	L	L	Н	READ	D
L	L	Н	L	WRITE	A & C
L	L	L	L	WRITE	B&D
H	H	Χ	Χ	HOLD	A/B/C/D
L	L	Н	Н	HOLD	A/B/C/D
L	L	L	Н	HOLD	A/B/C/D

L = LOW STATE H = HIGH STATE X = DON'T CARE





INTERFACE LOGIC INFORMATION

DAC Selection: All DAC latches share a common 8-bit input port. The control inputs $\overline{DS1}$, $\overline{DS2}$, A/B select which DAC can accept data from the input port.

Mode Selection: Inputs \overline{DS} and R/ \overline{W} control the operating mode of the selected DAC. See Mode Selection Table on the previous page.

Write Mode: When \overline{DS} and R/ \overline{W} are both low the selected DAC is in the write mode. The input data latches of the selected

DAC are transparent and its analog output responds to activity on DB0-DB7.

Hold Mode: The selected DAC latch retains the data which was present on DB0-DB7 just prior to \overline{DS} and R/ \overline{W} assuming a high state. Both analog outputs remain at the values corresponding to the data in their respective latches.

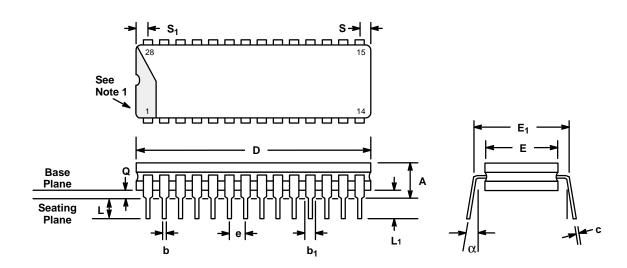
Read Mode: When \overline{DS} is low and R/ \overline{W} is high, the selected DAC is in the read mode and the data held in the appropriate latch is outputed to the data bus.

APPLICATION NOTES
Refer to Section 8 for Applications Information





28 LEAD CERAMIC DUAL-IN-LINE (600 MIL CDIP) D28



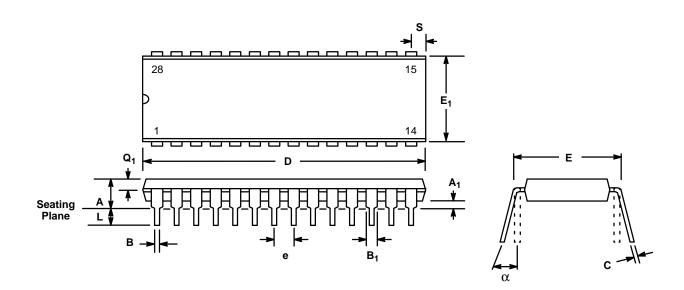
	INC	HES	MILLIN	METERS	
SYMBOL	MIN	MAX	MIN	MAX	NOTES
А	_	0.232		5.89	_
b	0.014	0.023	0.356	0.584	_
b ₁	0.038	0.065	0.965	1.65	2
С	0.008	0.015	0.203	0.381	_
D	_	1.490	_	37.85	4
E	0.500	0.610	12.70	15.49	4
E ₁	0.590	0.620	14.99	15.75	7
е	0.10	00 BSC	2.5	4 BSC	5
L	0.125	0.200	3.18	5.08	_
L ₁	0.150		3.81		_
Q	0.015	0.060	0.381	1.52	3
S	_	0.100	_	2.54	6
S ₁	0.005	_	0.13	_	6
α	0°	15°	0°	15°	_

NOTES

- Index area; a notch or a lead one identification mark is located adjacent to lead one and is within the shaded area shown.
- 2. The minimum limit for dimension b_1 may be 0.023 (0.58 mm) for all four corner leads only.
- 3. Dimension Q shall be measured from the seating plane to the base plane.
- 4. This dimension allows for off-center lid, meniscus and glass overrun.
- The basic lead spacing is 0.100 inch (2.54 mm) between centerlines.
- 6. Applies to all four corners.
- 7. This is measured to outside of lead, not center.



28 LEAD PLASTIC DUAL-IN-LINE (600 MIL PDIP) N28

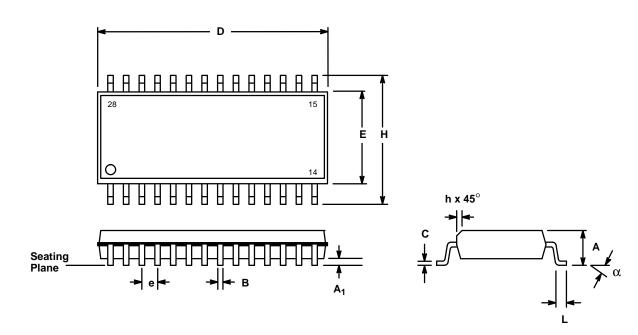


	INC	HES	MILLIN	METERS
SYMBOL	MIN	MAX	MIN	MAX
Α		0.232	_	5.893
A ₁	0.015		0.381	_
В	0.014	0.023	0.356	0.584
B ₁ (1)	0.038	0.065	0.965	1.65
С	0.008	0.015	0.203	0.381
D	1.380	1.490	35.05	37.85
Е	0.585	0.625	14.86	15.88
E ₁	0.500	0.610	12.70	15.49
е	0.10	00 BSC	2.5	4 BSC
L	0.115	0.150	2.92	3.81
α	0°	15°	0°	15°
Q ₁	0.055	0.070	1.40	1.78
S	0.020	0.100	1.508	2.54

Note: (1) The minimum limit for dimensions B1 may be 0.023" (0.58 mm) for all four corner leads only.



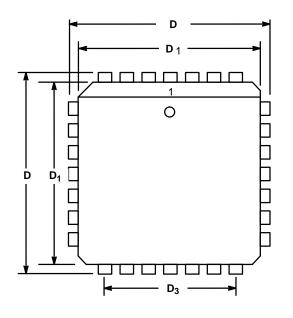
28 LEAD SMALL OUTLINE (300 MIL JEDEC SOIC) \$28

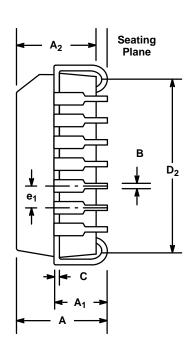


	INC	CHES	MILLIN	METERS
SYMBOL	MIN	MAX	MIN	MAX
А	0.097	0.104	2.464	2.642
A1	0.0050	0.0115	0.127	0.292
В	0.014	0.019	0.356	0.483
С	0.0091	0.0125	0.231	0.318
D	0.701	0.711	17.81	18.06
Е	0.292	0.299	7.42	7.59
е	0.0	50 BSC	1.2	7 BSC
Н	0.400	0.410	10.16	10.41
h	0.010	0.016	0.254	0.406
L	0.016	0.035	0.406	0.889
α	0°	8°	0°	8°



28 LEAD PLASTIC LEADED CHIP CARRIER (PLCC) P28





	INC	CHES	MILLI	METERS
SYMBOL	MIN	MAX	MIN	MAX
А	0.165	0.180	4.19	4.57
A ₁	0.100	0.110	2.54	2.79
A ₂	0.148	0.156	3.76	3.96
В	0.013	0.021	0.330	0.533
С	0.008	0.012	0.203	0.305
D	0.485	0.495	12.32	12.57
D ₁ (1)	0.450	0.454	11.43	11.53
D ₂	0.390	0.430	9.91	10.92
D ₃	0.300 Ref		7.6	2 Ref.
e ₁	0.0	50 BSC	1.2	7 BSC

Note: (1) Dimension D_1 does not include mold protrusion. Allowed mold protrusion is 0.254 mm/0.010 in.



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